

### 14N40K-MT

**Preliminary** 

# 14A, 400V N-CHANNEL POWER MOSFET

#### DESCRIPTION

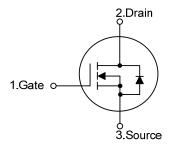
The UTC **14N40K-MT** is an N-Channel enhancement mode power MOSFET. The device adopts planar stripe and uses DMOS technology to minimize and provide lower on-state resistance and faster switching speed. It can also withstand high energy pulse under the avalanche and commutation mode conditions.

The UTC **14N40K-MT** is ideally suitable for high efficiency switch mode power supply, power factor correction and electronic lamp ballast based on half bridge topology.

#### FEATURES

- \*  $R_{DS(ON)}$  < 0.34 $\Omega$  @  $V_{GS}$  = 10V,  $I_D$  = 7A
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

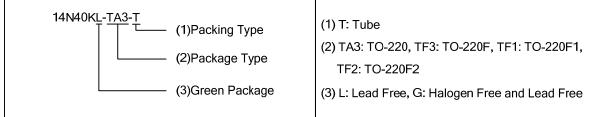
#### SYMBOL

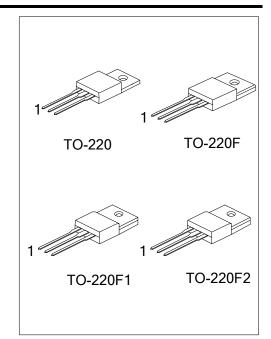


#### ORDERING INFORMATION

Ordering Number		Deekege	Pin Assignment			Deeking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
14N40KL-TA3-T	14N40KG-TA3-T	TO-220	G	D	S	Tube	
14N40KL-TF3-T	14N40KG-TF3-T	TO-220F	G	D	S	Tube	
14N40KL-TF1-T	14N40KG-TF1-T	TO-220F1	G	D	S	Tube	
14N40KL-TF2-T	14N40KG-TF2-T	TO-220F2	G	D	S	Tube	
Note: Din Assignment C. Cata							

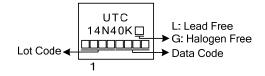
Note: Pin Assignment: G: Gate D: Drain S: Source





# 14N40K-MT

#### MARKING





#### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V <sub>DSS</sub>	400	V	
Gate-Source Voltage		V <sub>GSS</sub>	±30	V	
Continuous Drain Current		I <sub>D</sub>	14	А	
Pulsed Drain Current (Note 2)		I <sub>DM</sub>	48	А	
Avalanche Current (Note 2)		I <sub>AR</sub>	14	А	
Single Pulsed Avalanche Energy (Note 3)		E <sub>AS</sub>	535	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Power Dissipation (T <sub>C</sub> =25°C)	TO-220		150	W	
	TO-220F/TO-220F1 TO-220F2	P <sub>D</sub>	40	w	
Derate above 25°C	TO-220		1.2	W/°C	
	TO-220F/TO-220F1 TO-220F2		0.32	W/°C	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T <sub>STG</sub>	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by maximum junction temperature
- 3. L = 5.46mH, I\_{AS} = 14A, V\_{DD} = 50V, R\_G= 25\Omega, Starting T\_J = 25°C
- 4.  $I_{SD} \le 14A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

#### THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		$\theta_{JA}$	62.5	°C/W
Junction to Case	TO-220	θյς	0.83	°C/W
	TO-220F/TO-220F1 TO-220F2		3.125	°C/W

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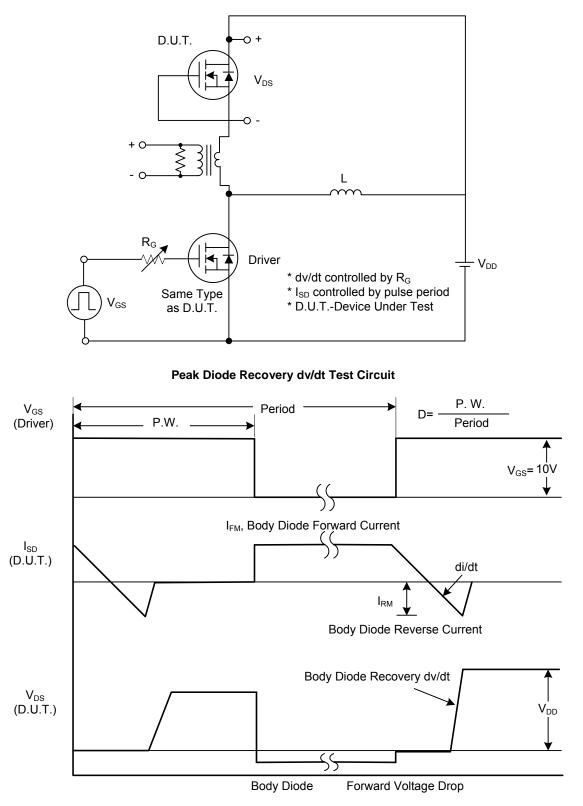
#### ■ ELECTRICAL CHARACTERISTICS (T<sub>c</sub>=25°C, unless otherwise specified)

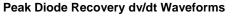
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	urce Breakdown Voltage $BV_{DSS}$ $V_{GS} = 0V$ , $I_D = 1mA$		400			V
Drain-Source Leakage Current	I <sub>DSS</sub>	$V_{DS} = 400 V, V_{GS} = 0 V$			10	μA
Cata Source Leakage Current	I <sub>GSS</sub>	$V_{GS} = 20V, V_{DS} = 0V$			100	nA
Gate-Source Leakage Current		$V_{GS}$ = -20V, $V_{DS}$ = 0V			-100	nA
Breakdown Voltage Temperature Coefficient	$\triangle \text{BV}_{\text{DSS}} / \triangle \text{T}_{\text{J}}$	I <sub>D</sub> =250mA,Referenced to 25°C		0.5		V/°C
ON CHARACTERISTICS						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$			4.0	V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 7A		0.26	0.34	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	CISS	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz		810		pF
Output Capacitance	C <sub>OSS</sub>			190		рF
Reverse Transfer Capacitance	C <sub>RSS</sub>			10.5		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge	$Q_{G}$	−V <sub>DS</sub> = 50V, V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.3A, −I <sub>D</sub> =100μA (Note 1, 2)		34.9		nC
Gate-Source Charge	$Q_{GS}$			9.1		nC
Gate-Drain Charge	$Q_{GD}$			8.8		nC
Turn-On Delay Time	t <sub>D(ON)</sub>	-V <sub>DS</sub> = 30V, V <sub>GS</sub> = 10V, I <sub>D</sub> = -0.3A, -R <sub>G</sub> = 25Ω (Note 1, 2)		66		nS
Turn-On Rise Time	t <sub>R</sub>			96		nS
Turn-Off Delay Time	t <sub>D(OFF)</sub>			200		nS
Turn-Off Fall Time	t <sub>F</sub>			112		nS
DRAIN-SOURCE DIODE CHARACTERISTIC	CS AND MAXI	MUM RATINGS				
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 14A			1.4	V
Maximum Continuous Drain-Source Diode	ls				14	А
Forward Current	IS				14	~
Maximum Pulsed Drain-Source Diode	I <sub>SM</sub>				56	A
Forward Current	1211					

Notes: 1. Pulse Test : Pulse width≤300µs, Duty cycle≤2%.

2. Essentially independent of operating ambient temperature.

#### TEST CIRCUITS AND WAVEFORMS





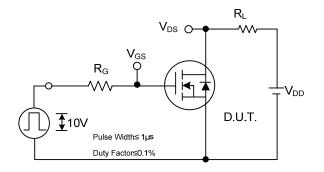


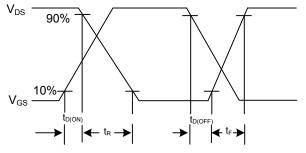
 $\mathsf{V}_{\mathsf{GS}}$ 

10V

Q<sub>GS</sub>

### TEST CIRCUITS AND WAVEFORMS (Cont.)



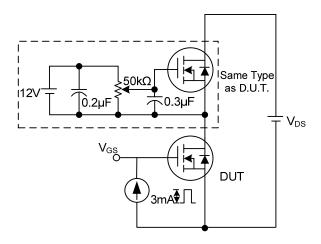


Switching Test Circuit

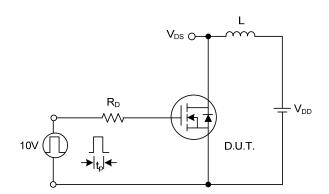


 $\mathsf{Q}_\mathsf{G}$ 

 $\mathsf{Q}_{\mathsf{GD}}$ 



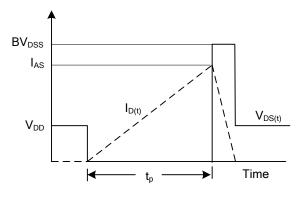
Gate Charge Test Circuit



**Unclamped Inductive Switching Test Circuit** 

**Gate Charge Waveform** 

Charge



**Unclamped Inductive Switching Waveforms** 



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